

A3  
--Guide rails for guiding a band-form member such as a film carrier tape in a semiconductor manufacturing apparatus. The guide rails include a pair of rail main bodies with a plurality of guide assemblies provided on the upper surfaces of the rail main bodies so that the guide assemblies partially guide the upper surface of the band-form member.--

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IN THE CLAIMS:

Please cancel claims 1 and 2 without prejudice.

Please add new claims 3-7 as follows:

1-3. Guide rails for conveying a band-form member comprising a pair of guide rails that are disposed facing each other so as to guide both sides of a band-form member, wherein said guide rails are comprised of rail main bodies and a plurality of guide members provided on said pair of rail main bodies, each of said guide members comprising a cylindrical member provided on said rail main bodies of a height greater than a thickness of said band-form member and a disk provided on said cylindrical member having a diameter greater than that of the cylindrical member.

A4  
2. The guide rails according to claim 1, wherein said plurality of guide members are provided on said rail main bodies at fixed intervals in a conveying direction of said band-form member so as to guide said band-form member in a width direction thereof.

3. The guide rails according to claim 1, wherein said disk is rotatably coupled to said cylindrical member.

4. The guide rails according to claim 3, wherein said cylindrical members are spaced apart in a transverse direction to said guide rails an amount equal to a width of the band-form member.

5. The guide rails according to claim 3, wherein said rotatable coupling between said disk and said cylinder comprises a pin provided on a top surface of said cylinder and a hole in a center of said disk which is rotatably fitted on said pin.--